

# SPECIFICATION FOR Near UV LED

# 3535 UVA LED PKG

### **DESCRIPTION**

The BR35LV405L01X is a UV LED package based on brilliant aluminum reflector with a peak wavelength of 405 nm.

In the case of aluminum, the reflectivity of the UV wavelength band is the best metal.

Moreover, reliability is also excellent because the LED PKG body radiates heat as a whole.



### **FEATURES**

- Brilliant Aluminum SMT package with Dome Lens
- Dimension (L x W x H) in mm
  - 3.5 x 3.5 x 2.5
- Forward current: up to 1,000 mA
- Radiant power (typ.)
  - 900 mW at 700 mA
- Viewing Angle  $(2\theta_{1/2})$ 
  - Typical 50°
- Built in ESD Protection device

### **APPLICATIONS**

- Sterilization
- Disinfection
- Chemical and Biological analysis
- Phototherapy
- Fluorescent Spectroscopy
- Counterfeit Detectors



# **Table of contents**

1. PKG Specifications	3
2. Bin Structures	. 4
3. Typical Characteristics Graphs	. 5
4. Outline Dimensions	6
5. Reflow Soldering Profile	7
6. Tape and Reel	8
7. Precautions on use 9-	11



# 1. PKG Specifications

### 1) Absolute maximum ratings

[Ta=25°C]

Parameters	Symbol	Value	Unit
Forward current	If	1000	mA
Power dissipation	Pd	3.6	W
Junction Temperature	Tj	100	°C
Operating temperature	Topr	- 30 ~ +60	°C
Storage temperature	Tstg	- 40 ~ +100	$^{\circ}$
Junction Temperature	Tj	100	°C
Soldering temperature	Tsol	260*)	°C
ESD Classification		Class2**)	

#### Notes

### 2) Electrical and Optical Characteristics

[Ta=25℃]

Parameter	Symbol	If	Min	Тур	Max	Unit
Peak wavelength	λр	700mA	400	405	410	nm
Radiant Flux	Фе	700mA	800	1000	1200	mW
Forward voltage	Vf	700mA	3.2	3.42	3.7	V
Full Width at Half Maximum	Δλ	700mA	20			nm
Viewing angle	2θ1/2	700mA	50			0
Thermal resistance	Rθ <sub>J-s</sub>	700mA	4.1			°C/W

#### Notes

- Peak Wavelength(λp) Measurement tolerance is ±3nm.
- Radiant Flux( $\Phi$ e) Measurement tolerance is  $\pm 10\%$ .
- Forward Voltage(Vf) Measurement tolerance is  $\pm 3\%$ .
- Viewing angle(deg) Measurement tolerance is ±5deg.

<sup>\*)</sup> Recommend JEDEC-J-STD-020D for reflow soldering.

<sup>\*\*)</sup> The ESD test follows JESD22-A114.



# 2. Bin Structures

[If=700mA, Ta=25℃]

Item	Bin	Min	Max	Unit
Peak Wavelength	W	400	410	nm
	R1	800	900	
Radiant Flux	R2	900	1000	mW
	R3	1000	1100	
Forward Voltage	V1	3.2	3.3	
	V2	3.3	3.4	
	V3	3.4	3.5	V
	V4	3.5	3.6	
	V5	3.6	3.7	

#### Notes

- Peak Wavelength( $\lambda p$ ) Measurement tolerance is  $\pm 3$ nm.
- Radiant Flux(Φe) Measurement tolerance is ±10%.
- Forward Voltage(Vf) Measurement tolerance is ±3%.



# 3. Typical Characteristics Graphs

1) Forward Current vs. Forward Voltage

[Ta=25°C]

1,000
(Y 800

1,000

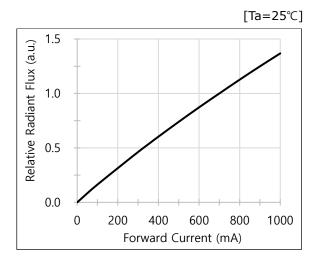
0

2

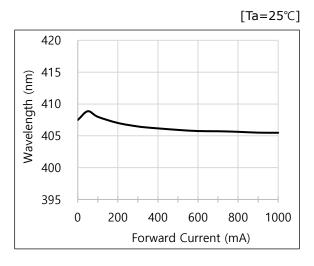
4

Forward Voltaget (V)

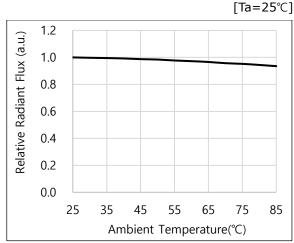
2) Relative Radiant Flux vs. Forward Current



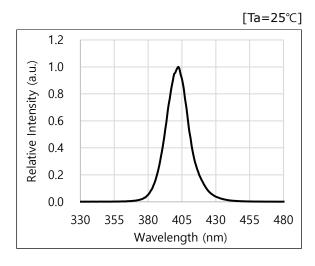
3) Peak Wavelength vs. Forward Current



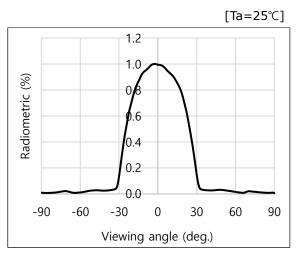
4) Ambient Temp. vs. Relative Radiant Flux



5) Spectrum



6) Typical Spatial Distribution

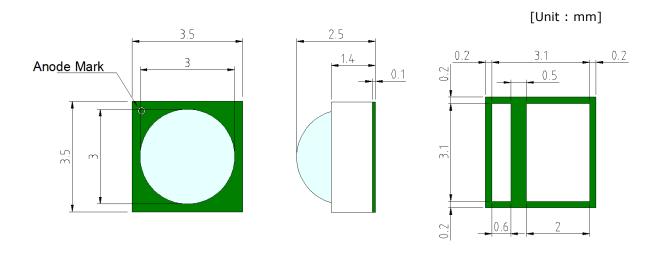




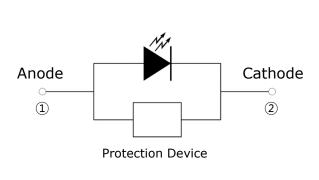
# 4. Outline Dimensions

# 1) PKG Dimensions

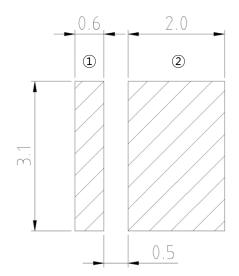
- PKG Dimensions 3.5 x 3.5 x 2.5 (L x W x H)
- Undefined tolerance is ±0.2mm



# 2) Internal Circuit

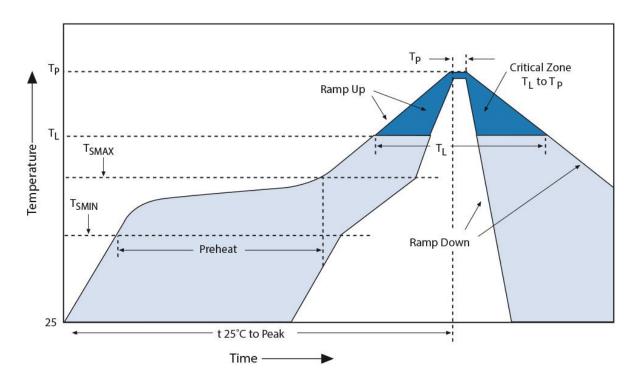


# 3) Recommended Solder Pad





# 5. Reflow Soldering Profile



### [ Classification Reflow Profiles ]

Profile Feature	Pb-free Assembly	Sn-Pb Eutectic Assembly
Average ramp-up rate (Ts <sub>max</sub> to Tp)	3°C/second max	3°C/second max
Preheat - Temperature Min (Ts <sub>min</sub> ) - Temperature Max (Ts <sub>max</sub> ) - Time (Ts <sub>min</sub> to Ts <sub>max</sub> ) (ts)	150 °C 200 °C 60-180 seconds	100 °C 150 °C 60-120 seconds
Time maintain above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	217 °C 60-150 seconds	183 °C 60-150 seconds
Peak Temperature (Tp)	260 ℃	235 ℃
Time within 5°C of actual Peak Temperature (tp)²	20-40 seconds	10-30 seconds
Ramp-down Rate	6 °C/second max	6 °C/second max
Time 25°C to Peak Temperature	8 minutes max.	6 minutes max.

### Notes

- All temperature refer to topside of the package, measured on the package body surface.
- The LED package is designed to be reflow soldered to a PCB. If dip soldered or hand soldered,
   PEC will not guarantee its reliability.
- Reflow soldering must not be done more than two times.
- When the LED PKG is cooled at the maximum temperature, a rapid temperature fall is not recommended.



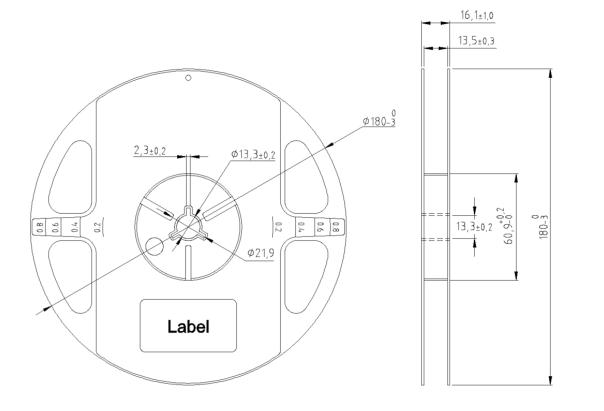
# 6. Taping and Reel packing

# 1) Tape

[Unit:mm] 10 SPRACKET HOLES F 5.50 ±0.10 **Anode Mark** P0 -E 1.75 ±0.10 4.00 ±0.10 P2 2.00 ±0.05 Ø1.50 +0.1 0.3 ±0.03 -- W 12.00 ±0.20 --5.0° REF B 3.75 ±0.05 − D1 K 1.90 ±0.05 Χ Ø1.50 MIN A 3.75 ±0.05 SECTION Y-Y 8.00 ±0.10 SECTION X-X

# 2) Reel

PKG Quantity: 500 PCS/Reel
 [Unit:mm]





### 7. Precautions on use

### 1) Storage condition

- This LED PKG is vacuum-packed in an aluminum bag containing a dehumidifying agent. However, if the storage environment is not good, the LED PKG can absorb moisture.
- When soldering with LED PKG absorb moisture, vaporization of moisture may occur and internal air may expand. This may cause the quartz to peel off or deteriorate its optical properties.
- It is recommended to keep in the environment shown in the table below.

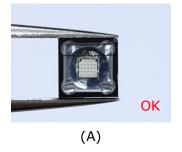
Conditions		Temperature	Humidity	Time	
Before Opening		5℃ ~ 30℃	< 50%RH	Within 1 Year from	
Storage	Aluminum Bag			the Delivery Date	
Storage	After Opening	5℃ ~ 30℃	< 60%RH	≤ 672 hours	
	Aluminum Bag		00,0111		
	Baking	65 ± 5℃	< 10%RH	10 ~ 24 hours	

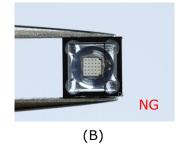
### 2) Circuit design

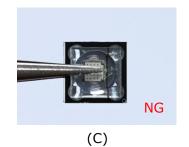
- When designing the circuit by applying the BR series, be sure to not exceed the absolute maximum ratings of each LED.
- For the BR series, it is designed to operate with forward voltage. If a reverse voltage is applied, the LED chip and the Zener diode can be damaged.
- For the current drive method, it is recommended to operate in the constant current mode.

#### 3) Handling precautions

- When handling the LED PKG using a tweezer, handle it in a direction parallel to the electrode separation line as shown in Fig. A below.
- When handling as shown in Fig. B, short-circuit failure may occur due to damage between electrode separation lines.
- When handling as shown in Fig. C, may cause quartz to break or scratch.









- Do not do rapid cooling immediately after soldering. It can cause the failure of the LED PKG.
- Handling the LED PKG by hand may contaminate the LED surface, which may cause the light output to drop.
- Dropping the LED PKG may cause LED damage.

### 4) ESD (Electrostatic Discharge)

- Use all objects and materials in the workplace for anti-static measures.
- Grounding
- ① All instruments, JIG, and equipment in the workplace should be grounded and measured once a month by a ground resistance meter.
- ② Workers should wear antistatic clothing and ground through a wrist strap or heel ground. Earth ring should be connected so as not to be shaken when grounding, and check for disconnection every day.
- The working surface of the work table is provided with a conductive mat and grounded. Periodically measure and check the conductivity state.
- The work table preferably has a surface resistance of 105 to 109 [ $\Omega$ /SQ], and the metal work table is not good. (Breakage due to rapid discharge)
- Install conductive tiles or mats and regularly measure and manage grounding resistance and static electricity.
- Partially high static electricity is generated such as rotating body, TV, monitor, JIG. If it is non-conductive, use ionizer or anti-static spray regularly and prevent static electricity.
- In addition to general cases, use humidity control or partial humidifier to suppress the generation of static electricity.

### 5) Thermal Management

- Thermal management is closely related to the lifetime of LEDs.
- The temperature of the LED during operation must not exceed the junction temperature (Tj).
- For temperature management of the LED, the thermal resistance of the PCB and the spacing between the LEDs must be considered.
- For PCBs, a Cu based metal PCB is recommended, and if necessary, a heat sink should be attached to manage the LED temperature.



### 6) Eye Safety

- This UV LED PKG emits high power UV light.
- Exposure to light with strong UV light can cause damage to the human eye and skin.
- Do not look directly or indirectly at UV light.
- If exposure to UV light is unavoidable, the body should be protected by suitable protection devices such as goggles and clothing.
- Attach the following warning labels on products/systems that use UV LEDs.



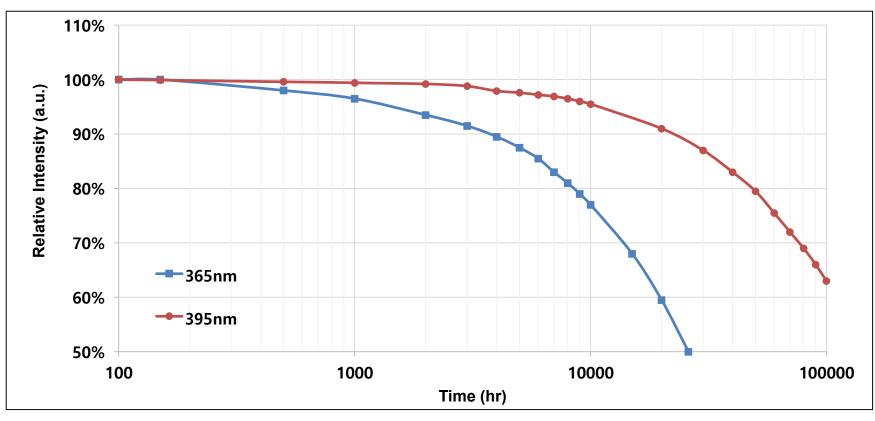


# 3535UVA PKG lifetime Extrapolation





# BR35QVXXXL01X / BR35LVXXXL01X Series

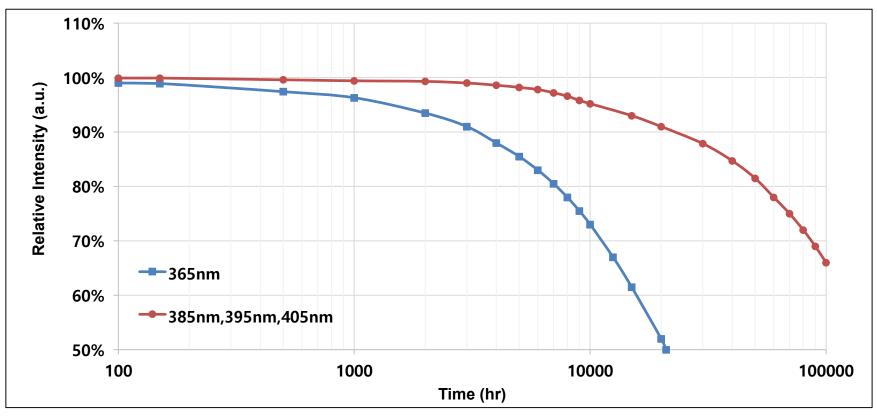


No.	Wp(nm)	If(mA)	Ta(℃)	Tj(℃)	Calculated L70	Calculated L80
1	365	500	50	75	~ 15,000	~ 9,000
2	385, 395, 405	500	50	71	~ 70,000	~ 40,000

<sup>\*</sup> All characteristics shown are for reference only and are not guaranteed.



# AO35LLXXXX01X / AO35LVXXXX01X Series



No.	Wp(nm)	If(mA)	Tj(℃)	Calculated L70	Calculated L80
1	365	350	60	~ 10,000	~ 7,000
2	385, 395, 405	350	60	~ 80,000	~ 50,000

<sup>\*</sup> All characteristics shown are for reference only and are not guaranteed.

